



PRESS RELEASE

FOR IMMEDIATE RELEASE

Dage expands Bond Test sales organization

July 2, 2007, Fremont, California – In continuation with its overall growth strategy, Dage Precision Industries is pleased to announce the appointment of Cynthia Andersen as National Sales Manager, Bond Test. Ms. Andersen will be responsible for all bond tester sales throughout the United States, Canada, Mexico as well as Central and South America.

Previously with ITW Simco for more than 7 years, Andersen brings a wealth of knowledge and experience in the semiconductor fabrication and component backend industry to the Dage team. Her attraction to joining Dage was the opportunity to play a leadership role in the semiconductor equipment industry during a pivotal time in the ongoing transition to lead-free materials and processes.

Andersen stated, “The dramatic changes required in lead-free conversion represent a unique challenge and Dage has exactly the right tool at precisely the right time to provide meaningful test data essential for successful lead-free implementation. The Dage 4000HS High Speed Bondtester is a meaningful and powerful tool that has established a new paradigm in bond test methodology and allows customers to test components and bond interfaces beyond the capabilities of previous test equipment.”

With Americas headquarters located in Fremont, California, Dage Precision Industries, Inc. manufactures and supports a complete range of award winning digital x-ray inspection systems and bond test equipment for the printed circuit board assembly and semiconductor industries. For more information, visit www.dage-group.com.

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